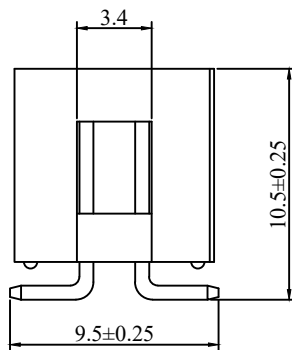
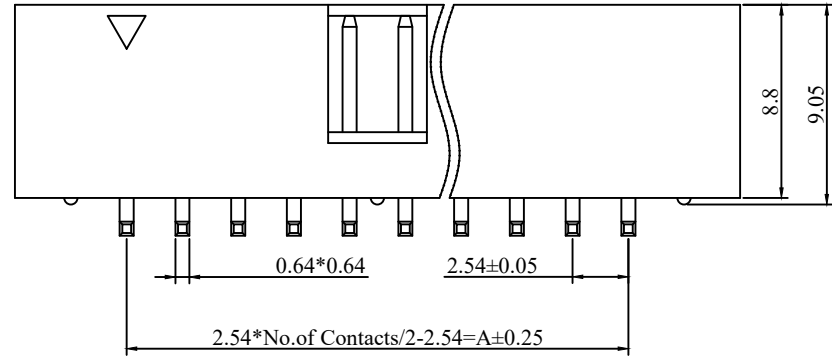
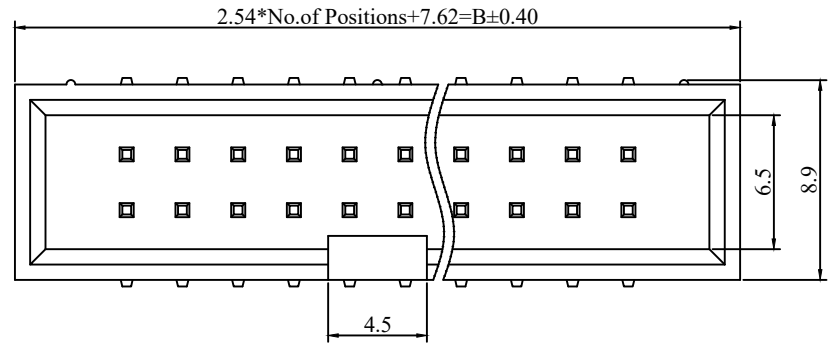


RoHS

REV	ECN NO.	DESCRIPTION	DESIGN	APPROVAL	DATE
A1	NEW	更换图框			2023.11.25



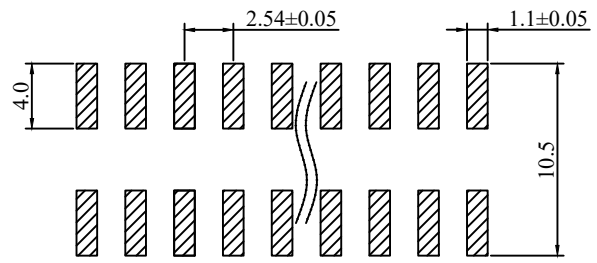
Specifications
 Current Rating: 3.0Ampere
 Insulation Resistance: 1000MΩ MIN.
 Dielectric Withstanding: 600V AC
 Contact Resistance: 20mΩ Max.
 Operating Temperature: -40°C to +105°C
 Max. Processing Temp: 240°C -260°C for 30-60seconds
 (260°C for 10 seconds)

Material
 Contact Material: Copper Alloy
 Contact Plating: Gold/Tin Over Nickel
 Insulator: Glass Filled Polyester
 Nylon6T (UL 94V-0)

料号说明：
BH254VS-xxP
 1 2

1. 序列号
2. Pin位数 (06-68)
 06=2x3P
 64=2x32P

No. of Pins/Row	Dimension	
	A	B
06	5.08	15.24
08	7.62	17.78
10	10.16	20.32
12	12.70	22.86
14	15.24	25.40
16	17.78	27.94
18	20.32	30.48
20	22.86	33.02
24	27.94	38.10
26	30.48	40.64
30	35.56	45.72
34	40.64	50.80
40	48.26	58.42
28	33.02	43.18
60	73.66	83.85
64	78.74	88.93
~	~	~



P.C.B Hole Layout

X.±0.50	X.°±
.X±0.25	.X°±
.XX±0.15	.XX°±
.XXX±0.10	.XXX°±
UNITS:	mm

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PART NO: BH254VS-xxP	
TITLE: 筒牛2.54/XP SMD 黑	
APPD	
CHKD	
DRAW	Wang
DATE	2023.11.25

XFCN 兴飞连接器

0769-82001899
 www.xfconn.com

DWG NO: /

VIEW	
SCALE	NONE
SHEET	1:1
REV	A1